

EM MICROELECTRONIC-MARIN SA

A COMPANY OF THE **SWATCH GROUP**

A6250

High Efficiency Linear Power Supply with Accurate Power Surveillance and Software Monitoring

Features

- Highly accurate 5 V, 250 mA guaranteed output
- Low dropout voltage, typically 260 mV at 250 mA
- Low quiescent current, typically 175 μA
- Standby mode, maximum current 340 μA (with 100 μA load on OUTPUT)
- Unregulated DC input can withstand -20 V reverse battery and +60 V power transients
- Fully operational for unregulated DC input voltage up to 40 V and regulated output voltage down to 3.0 V
- Reset output guaranteed for regulated output voltage down to 1.2 V
- No reverse output current
- Very low temperature coefficient for the regulated output
- Current limiting
- Comparator for voltage monitoring, voltage reference 1.52 V
- Programmable reset voltage monitoring
- Programmable power on reset (POR) delay
- Watchdog with programmable time windows guarantees a minimum time and a maximum time between software clearing of the watchdog
- Time base accuracy ±10%
- System enable output offers added security
- TTL/CMOS compatible
- -40 to +125°C temperature range
- PSOP2-16 package

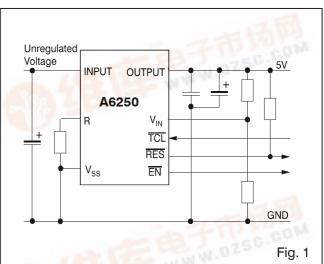
Description

The A6250 offers a high level of integration by combining voltage regulation, voltage monitoring and software monitoring in a 16 lead package. The voltage regulator has a low dropout voltage (typ. 260 mV at 250 mA) and a low quiescent current (175 μ A). The quiescent current increases only slightly in dropout prolonging battery life. Built-in protection includes a positive transient absorber for up to 60 V (load dump) and the ability to survive an unregulated input voltage of -20 V (reverse battery). The input may be connected to ground or a reverse voltage without reverse current flow from the output to the input. A comparator monitors the voltage applied at the VIN input comparing it with an internal 1.52 V reference. The power-on reset function is initialized after V_{IN} reaches 1.52 V and takes the reset output inactive after T_{POR} depending of external resistance. The reset output goes active low when the V_{IN} voltage is less than 1.52 V. The RES and EN outputs are guaranteed to be in a correct state for a regulated output voltage as low as 1.2 V. The watchdog function monitors software cycle time and execution. If software clears the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution) it will cause the system to be reset. The system enable output prevents critical control functions being activated until software has successfully cleared the watchdog three times. Such a security could be used to prevent motor controls being energized on repeated resets of a faulty system.

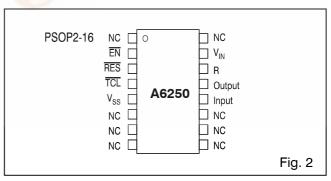
Applications

- Industrial electronics
- Cellular telephones
- Security systems
- Battery powered products
- High efficiency linear power supplies
- Automotive electronics

Typical Operating Configuration



Pin Assignment





Absolute Maximum Ratings

Parameter	Symbol	Conditions
Continuous voltage at INPUT to		
V _{ss}	V_{INPUT}	-0.3 to +45 V
Transients on INPUT for		
t< 100 ms and duty cycle 1%	V_{TRANS}	up to +60 V
Reverse supply voltage on INPUT	V_{REV}	-20 V
Max. voltage at any signal pin	V_{MAX}	OUTPUT+0.3V
Min. voltage at any signal pin	V_{MIN}	V_{SS} -0.3V
Storage temperature	T _{STO}	-65 to +150°C
Operating junction temperature	T_J	max. 150 °C
Electrostatic discharge max. To		
MIL-STD-883C method 3015	V_{Smax}	1000V
Max. soldering conditions	T _{Smax}	250°C x 10 s
Max. Output current	OUTPUTmax	300 mA

Table 1

Stresses above these listed maximum ratings may cause permanent damage to the device. Exposure beyond specified operating conditions may affect device reliability or cause malfunction.

Decoupling Methods

The input capacitor is necessary to compensate the line influences. A resistor of approx. 1 Ω connected in series with the input capacitor may be used to damp the oscillation of the input capacitor and input inductivity. The ESR value of the capacitor plays a major role regarding the efficiency of the decoupling. It is recommended also to connect a ceramic capacitor (100 nF) directly at the IC's pins. In general the user must assure that pulses on the input line have slew rates lower than 1 $V/\mu s$. On the output side, the capacitor is necessary for the stability of the regulation circuit. The stability is guaranteed for values of 22 μ F or bigger. It is specially important to choose a capacitor with a low ESR value. Tantal capacitors are recommended. See the notes related to Table 2. Special care must be taken in disturbed environments (automotive, proximity of motors and relays, etc.).

Handling Procedures

This device has built-in protection against high static voltages or electric fields; however, anti-static precautions must be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept within the supply voltage range. Unused inputs must always be tied to a defined logic voltage level.

Operating Conditions

Parameter	Symbol	Min.	Max.	Units
Operating junction				
temperature ¹⁾	T,	-40	+125	°C
INPUT voltage 2)	VI _{NPUT}	2.3	40	V
OUTPUT voltage 2) 3)	V _{OUTPUT}	1.2		V
RES & EN guaranteed 4)	V _{OUTPUT}	1.2		V
OUTPUT current 5)	I _{OUTPUT}		250	mA
Comparator input voltage	V _{IN}	0	V_{OUTPUT}	V
RC-oscillator programming 6)	R	10	1000	kΩ
Thermal resistance from				
junction to ambient 7)				
- PSOP2-16	$R_{\text{th(j-a)}}$	30	90	°C/W

Table 2

- 1) The maximum operating temperature is confirmed by sampling at initial device qualification. In production, all devices are tested at +125°C.
- ²⁾ Full operation guaranteed. To achieve the load regulation specified in Table 3 a 22 μ F capacitor or greater is required on the INPUT, see Fig. 8. The 22 μ F must have an effective resistance \leq 5 Ω and a resonant frequency above 500 kHz.
- $^{3)}$ A 10 μF load capacitor and a 100 nF decoupling capacitor are required on the regulator OUTPUT for stability. The 10 μF must have an effective series resistance of \leq 5 Ω and a resonant frequency above 500 kHz.
- ⁴⁾ RES must be pulled up externally to V_{OUTPUT} even if it is unused. (Note: RES and EN are used as inputs by EM test.)
- 5) The OUTPUT current will not apply for all possible combinations of input voltage and output current. Combinations that would require the A6250 to work above the maximum junction temperature (+125 °C) must be avoided.
- $^{6)}$ Resistor values close to 1000 kΩ are not recommended for applications working at 125 °C.
- 7) The thermal resistance specified assumes the package is soldered to a PCB. The termal resistance's value depends on the PCB's structure. A typical value of 51 °C/W has been obtained with a dual layer board, with the slug soldered to the heat-sink area of the PCB (see Fig. 22).



Electrical Characteristics

 $V_{INPUT} = 6.0 \text{ V}$, $C_L = 10 \,\mu\text{F} + 100 \,\text{nF}$, $C_{INPUT} = 22 \,\mu\text{F}$, $T_J = -40 \,\text{to} + 125 \,^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Тур.	Мах.	Unit
Supply current in standby mode	I _{SS}	$R_{EXT} = don't care, TCL = V_{OUTPUT},$				
		$V_{IN} = 0 \text{ V}, I_{L} = 100 \mu\text{A}$		140	340	μΑ
Supply current 1)	I _{SS}	$R_{EXT} = 100 \text{ k}\Omega$, I/Ps at V_{OUTPUT} ,				
		O/Ps 1 M Ω to V _{OUTPUT} , I _L = 100 μ A		175	400	μΑ
Supply current 1)	I _{ss}	$R_{EXT} = 100 \text{ k}\Omega$, I/Ps at V_{OUTPUT} ,				
		$V_{INPUT} = 8.0 \text{ V}, \text{ O/Ps } 1\text{M}\Omega \text{ to } V_{OUTPUT},$				
		$I_L = 100 \text{ mA}$		1.7	4.2	mA
		$I_L = 250 \text{ mA}$		7	15	mA
Output voltage	V_{OUTPUT}	$I_L = 100 \mu\text{A}$	4.85		5.15	V
Output voltage	V_{OUTPUT}	$100 \mu A \le I_L \le 250 \text{mA},$	4.85		5.15	V
Output voltage temperature						
coefficient 2)	$V_{\text{th(coeff)}}$			100		ppm/°C
Line regulation 3)	V_{LINE}	$6 \text{ V} \leq \text{V}_{\text{INPUT}} \leq 35 \text{ V}, I_{\text{L}} = 1 \text{ mA},$				
		$T_{J} = +125^{\circ}C$		0.2	8.0	%
Load regulation ³⁾	V_L	$100 \mu \text{A} \le \text{I}_{\text{L}} \le 100 \text{mA}$		0.2	0.7	%
Load regulation 3)	V_L	$5 \text{ mA} \le I_L \le 250 \text{ mA}$		0.9	1.45	%
Dropout voltage 4)	$V_{DROPOUT}$	$I_L = 100 \mu\text{A}$		40	170	mV
Dropout voltage 4)	$V_{DROPOUT}$	$I_L = 100 \text{ mA}$		160	3805)	mV
Dropout voltage 4)	$V_{DROPOUT}$	$I_L = 250 \text{ mA}$		260	650	mV
Dropout supply current	I _{ss}	$V_{INPUT} = 4.5 \text{ V}, I_{L} = 100 \mu\text{A},$				
		$R_{EXT} = 100 \text{ k}\Omega$, O/Ps 1 M Ω to				
		V _{OUTPUT} , I/Ps at V _{OUTPUT}		1.2	1.8	mA
Current limit	I _{Lmax}	OUTPUT tied to V _{ss}		450		mA
OUTPUT noise, 10 Hz to 100 kHz	V_{NOISE}			200		μV rms

 $4.5 \le V_{\text{OUTPUT}} \le 5.5 \text{ V}$, $I_L = 100 \,\mu\text{A}$. $C_L = 10 \,\mu\text{F} + 100 \,\text{nF}$, $C_{\text{INPUT}} = 22 \,\mu\text{F}$, $T_J = -40 \,\text{to} + 125 \,^{\circ}\text{C}$, unless otherwise specified

RES and EN						
Output Low Voltage	V _{OL}	$V_{OUTPUT} = 4.5 \text{ V}, I_{OL} = 20 \text{ mA}$		0.4		V
	V _{OL}	$V_{OUTPUT} = 4.5 \text{ V}, I_{OL} = 8 \text{ mA}$		0.2	0.4	V
	V _{OL}	$V_{OUTPUT} = 2.0 \text{ V}, I_{OL} = 4 \text{ mA}$		0.2	0.4	V
	V _{OL}	$V_{OUTPUT} = 1.2 \text{ V}, I_{OL} = 0.5 \text{ mA}$		0.06	0.2	V
EN		1				
Output High Voltage	V_{OH}	$V_{OUTPUT} = 4.5 \text{ V}, I_{OH} = -1 \text{ mA}$	3.5	4.1		V
	V_{OH}	$V_{OUTPUT} = 2.0 \text{ V}, I_{OH} = -100 \mu\text{A}$	1.8	1.9		V
	V_{OH}	$V_{OUTPUT} = 1.2 \text{ V}, I_{OH} = -30 \mu\text{A}$	1.0	1.1		V
TCL and V _{IN}						
TCL Input Low Level	V _{IL}		V_{ss}		0.8	V
TCL Input High Level	V _{IH}		2.0		V _{OUTPUT}	V
Leakage current TCL input	I _U	$V_{SS} \leq V_{TCL} \leq V_{OUTPUT}$		0.05	1	μ A
V _{IN} input resistance	R_{VIN}			100		MΩ
Comparator reference 6) 7)	V _{REF}	$T_J = +25^{\circ}C$	1.474	1.52	1.566	V
	V _{REF}		1.436		1.620	V
	V _{REF}	-40°C ≤ T _J ≤ +125°C	1.420		1.620	V
Comparator hysteresis 7)	V _{HY}			2		mV

Table 3

 $^{^{1)}}$ If INPUT is connected to V_{ss}, no reverse current will flow from the OUTPUT to the INPUT, however the supply current specified will be sank by the OUTPUT to supply the A6250.

²⁾ The OUTPUT voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.

³⁾ Regulation is measured at constant junction temperature using pulse testing with a low duty cycle. Changes in OUTPUT voltage due to heating effects are covered in the specification for thermal regulation.

⁴⁾ The dropout voltage is defined as the INPUT to OUTPUT differential, measured with the input voltage equal to 5.0 V.

⁵⁾ Not tested.

⁶⁾ The comparator and the voltage regulator have separate voltage references (see Block Diagram Fig. 7).

⁷⁾ The comparator reference is the power-down reset threshold. The power-on reset threshold equals the comparator reference voltage plus the comparator hysteresis (see Fig. 4).



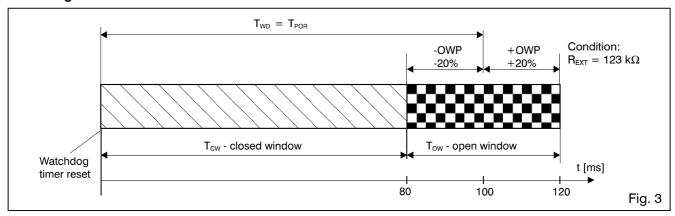
Timing Characteristics $V_{\text{INPUT}} = 6.0 \text{ V, I}_{\text{L}} = 100 \, \mu\text{A, C}_{\text{L}} = 10 \, \mu\text{F} + 100 \, \text{nF, C}_{\text{INPUT}} = 22 \, \mu\text{F, T}_{\text{J}} = -40 \, \text{to} + 125 ^{\circ}\text{C, unless otherwise specified}$

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Propagation delays:						
TCL to Output Pins	T _{DIDO}			250	500	ns
V _{IN} sensitivity	T _{SEN}		1	5	20	μs
Logic Transition Times on all						
Output Pins	T _{TR}	Load 10 kΩ, 50 pF		30	100	ns
Power-on Reset delay	T _{POR}	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Watchdog Time	T_{WD}	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Open Window Percentage	OWP			$\pm 0.2 T_{WD}$		
Closed Window Time	T_CW			$0.8 T_{WD}$		
	T _{CW}	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	72	80	88	ms
Open Window Time	T_{oW}			0.4 T _{WD}		
	T_OW	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	36	40	44	ms
Watchdog Reset Pulse	T _{WDR}			$T_{WD} / 40$		
	T _{WDR}	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$		2.5		ms
T _{CL} Input Pulse Width	T _{TCL}		150			ns

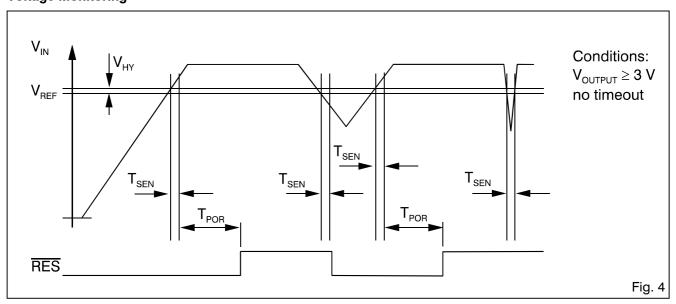
Table 4

Timing Waveforms

Watchdog Timeout Period

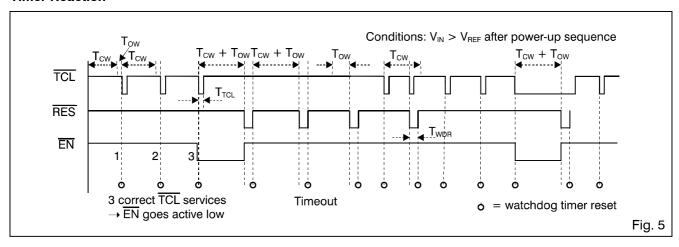


Voltage Monitoring

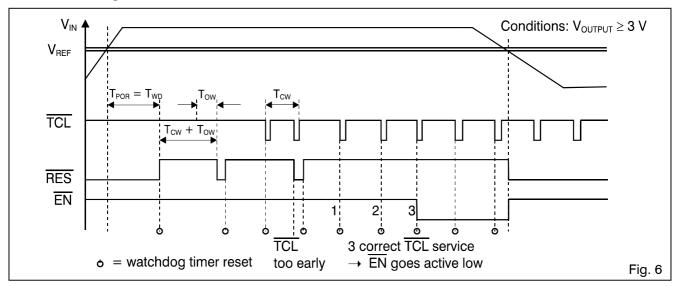




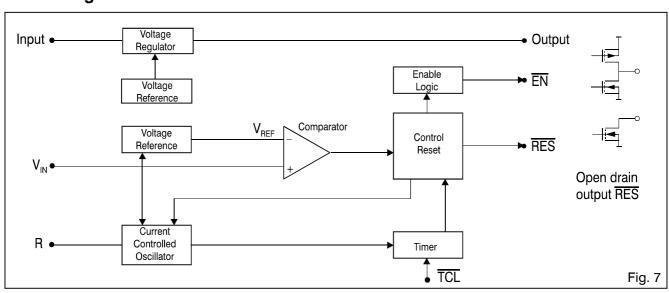
Timer Reaction



Combined Voltage and Timer Reaction



Block Diagram





Pin Description

	•	
Pin	Name	Function
2	EN	Push-pull active low enable output
3	RES	Open drain active low reset output.
		RES must be pulled up to V _{OUTPUT}
		even if unused
4	TCL	Watchdog timer clear input signal
5	V_{SS}	GND terminal
12	INPUT	Voltage regulator input
13	OUTPUT	Voltage regulator output
14	R	R _{EXT} input for RC oscillator tuning
15	V _{IN}	Voltage comparator input

Table 5

Functional Description

Voltage Regulator

The A6250 has a 5 V \pm 3%, 250 mA, low dropout voltage regulator. The low supply current (typ. 175 μ A) makes the A6250 particularly suited to automotive systems then remain energized 24 hours a day. The input voltage range is 2.3 V to 40 V for operation and the input protection includes both reverse battery (20 V below ground) and load dump (positive transients up to 60 V). There is no reverse current flow from the OUTPUT to the INPUT when the INPUT equals V_{ss}. This feature is important for systems which need to implement (with capacitance) a minimum power supply hold-up time in the event of power failure. To achieve good load regulation a 22 μF capacitor (or greater) is needed on the INPUT (see Fig. 8). Tantalum or aluminium electrolytics are adequate for the 22 µF capacitor; film types will work but are relatively expensive. Many aluminium electrolytics have electrolytes that freeze at about -30°C, so tantalums are recommended for operation below -25°C. The important parameters of the 22 μ F capacitor are an effective series resistance of $\leq 5 \Omega$ and a resonant frequency above 500 kHz.

A 10 μ F capacitor (or greater) and a 100 nF capacitor are required on the OUTPUT to prevent oscillations due to instability. The specification of the 10 μ F capacitor is as per the 22 μ F capacitor on the INPUT (see previous paragraph).

The A6250 will remain stable and in regulation with no external load and the dropout voltage is typically constant as the input voltage fall to below its minimum level (see Table 2). These features are especially important in CMOS RAM keep-alive applications.

Care must be taken not to exceed the maximum junction temperature (+125°C). The power dissipation within the A6250 is given by the formula:

 $P_{TOTAL} = (V_{INPUT} - V_{OUTPUT})$. $I_{OUTPUT} + (V_{INPUT})$. I_{SS} The maximum continuous power dissipation at a given temperature can be calculated using the formula:

 $P_{MAX} = (125^{\circ}C - T_{A}) / Rth(j-a)$

where Rth(j-a) is the thermal resistance from the junction to the ambient and is specified in Table 2. Note the $R_{th(j-a)}$ given in Table 2 assumes that the package is soldered to a PCB. The above formula for maximum power dissipation

assumes a constant load (ie. \geq 100 s). The transient thermal resistance for a single pulse is much lower than the continuous value.

V_{IN} Monitoring

The power-on reset and the power-down reset are generated as a response to the external voltage level on the V_{IN} input. The external voltage level is typically obtained from a voltage divider as shown in Fig. 8. The user uses the external voltage divider to set the desired threshold level for power-on reset and power-down reset in his system. The internal comparator reference voltage is typically 1.52 V. At power-up the reset output (RES) is held low (see Fig. 4). After INPUT reaches 3.36 V (and so OUTPUT reaches at least 3 V) and V_{IN} becomes greater than V_{REF} , the RES output is held low for an additional power-on-reset (POR) delay which is equal to the watchdog time T_{WD} (typically 100 ms with an external resistor of 123 k Ω connected at R pin). The POR delay prevents repeated toggling of RES even if V_{IN} and the INPUT voltage drops out and recovers. The POR delay allows the microprocessor's crystal oscillator time to start and stabilize and ensures correct recognition of the reset signal to the microprocessor.

The $\overline{\text{RES}}$ output goes active low generating the power-down reset whenever V_{IN} falls below V_{REF} . The sensitivity or reaction time of the internal comparator to the voltage level on V_{IN} is typically 5 μ s.

Timer Programming

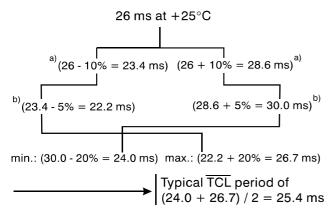
The on-chip oscillator with an external resistor R_{EXT} connected between the R pin and V_{SS} (see Fig. 8) allows the user to adjust the power-on reset (POR) delay, watchdog time T_{WD} and with this also the closed and open time windows as well as the watchdog reset pulse width $(T_{\text{WD}}\,/\,40).$ With $R_{\text{EXT}}=123~\text{k}\Omega$ typical values are:

Note the current consumption increases as the frequency increases.



Watchdog Timeout Period Description

The watchdog timeout period is divided into two parts, a "closed" window and an "open" window (see Fig. 3) and is defined by two parameters, T_{WD} and the Open Window Percentage (OWP). The closed window starts just after the watchdog timer resets and is defined by $T_{CW} = T_{WD} - OWP(T_{WD})$. The open window starts after the closed time window finishes and lasts till $T_{WD} + OWP(T_{WD})$. The open window time is defined by $T_{OW} = 2 \times OWP(T_{WD})$.



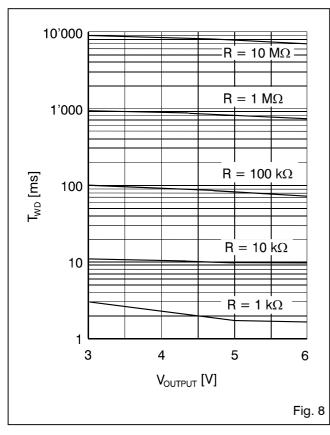
For example if $T_{WD}=100$ ms (actual value) and $OWP=\pm20\%$ this means the closed window lasts during first the 80 ms ($T_{CW}=80$ ms = 100 ms - 0.2 (100 ms)) and the open window the next 40 ms ($T_{CW}=2\,x\,0.2$ (100 ms) = 40 ms). The watchdog can be serviced between 80 ms and

120 ms after the timer reset. However as the time base is $\pm 10\%$ accurate, software must use the following calculation for servicing signal \overline{TCL} during the open window: Related to curves (Fig. 10 to Fig. 20), especially Fig. 19 and Fig. 20, the relation between T_{WD} and R_{EXT} could easily be defined. Let us take an example describing the variations due to production and temperature:

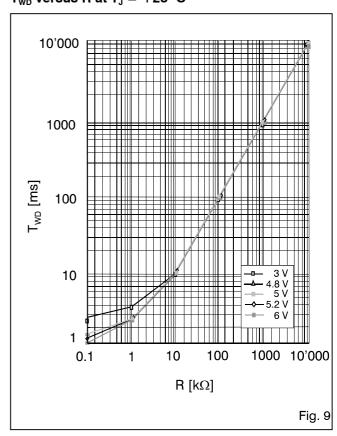
- 1. Choice, $T_{WD} = 26 \text{ ms.}$
- 2. Related to Fig. 20, the coefficient (T_{WD} to R_{EXT}) is 1.125 where R_{EXT} is in $k\Omega$ and T_{WD} in ms.
- 3. R_{EXT} (typ.) = 26 x 1.155 = 30.0 k Ω .
- 4. The ratio between $T_{WD} = 26$ ms and the (\overline{TCL} period) = 25.4 ms is 0.975. Then the relation over the Production and the full temperature range is, \overline{TCL} period = 0.975 x T_{WD} 0.975 x T_{EXT} or \overline{TCL} period = $\frac{0.975 \text{ x Rext}}{1.155}$, as typical value.
 - a) ± 10 % while PRODUCTION value unknown for the customer when $R_{\text{EXT}} \neq 123 \text{ k}\Omega$.
 - b) ± 5 % while operating TEMPERATURE range $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le +125^{\circ}\text{C}$.
- 5. If you fixed a \overline{TCL} period = 26 ms $\Rightarrow R_{EXT} = \frac{26 \times 1.155}{0.075} = 30.8 \text{ k}\Omega.$

If during your production the T_{WD} time can be measured at $T_J = \pm 25^{\circ}C$ and the μC can adjust the \overline{TCL} period, then the \overline{TCL} period range will be much larger for the full operating temperature.

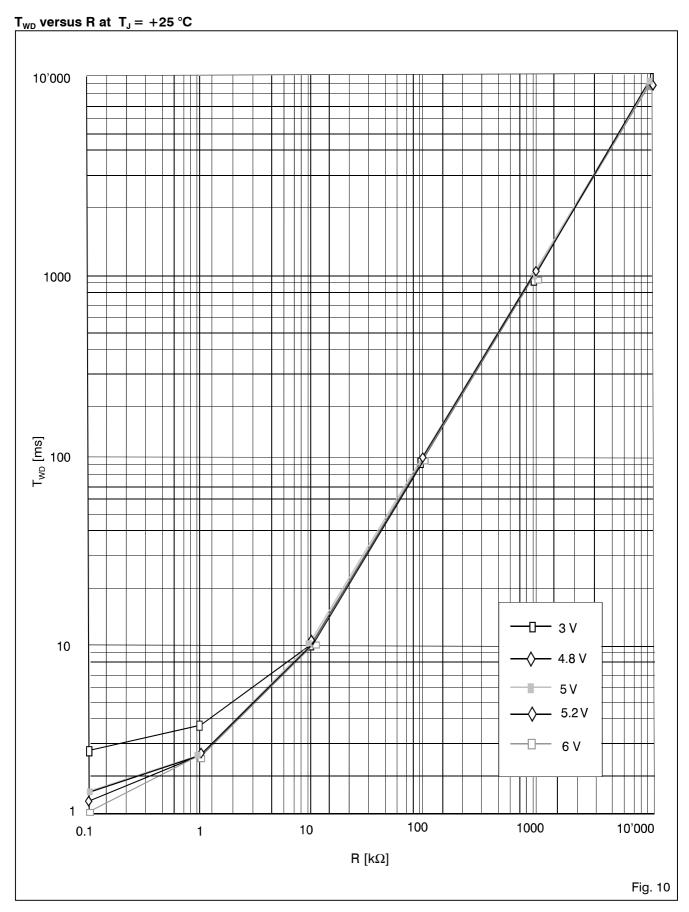
 T_{WD} versus V_{OUTPUT} at $T_{J} = +25$ °C



 T_{WD} versus R at $T_{J} = +25$ °C



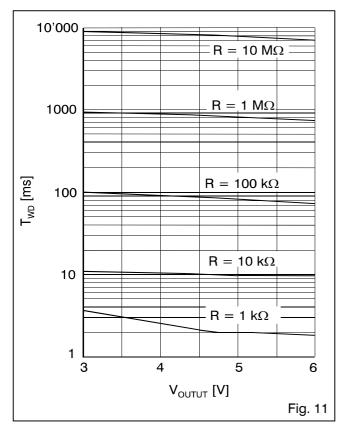




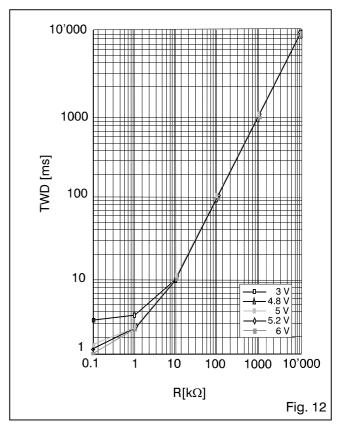
A6250



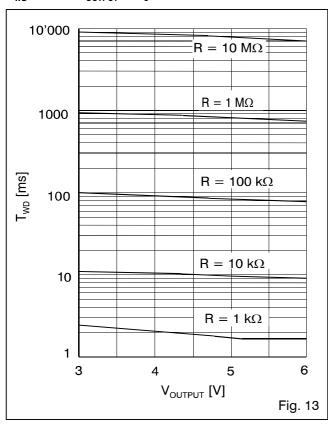
T_{WD} versus V_{OUTPUT} at $T_{J} = +85$ °C



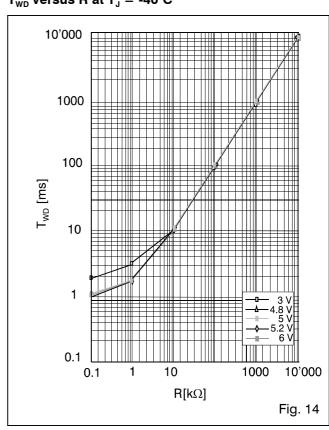
 T_{WD} versus R at $T_J = \, +85 \,\, ^{\circ}\text{C}$



 T_{WD} versus V_{OUTPUT} at $T_{\text{J}} =$ -40 $^{\circ}\text{C}$



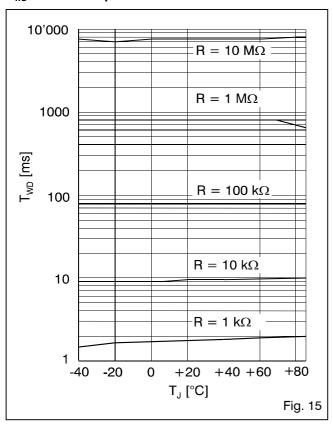
 T_{WD} versus R at $T_{\text{J}} = \text{-40}^{\circ}\text{C}$



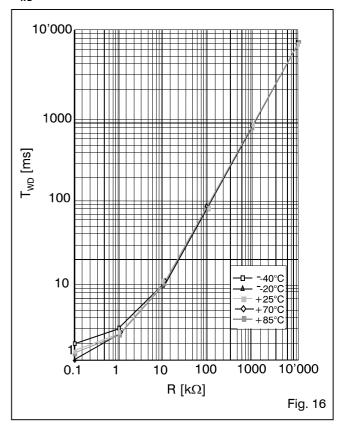




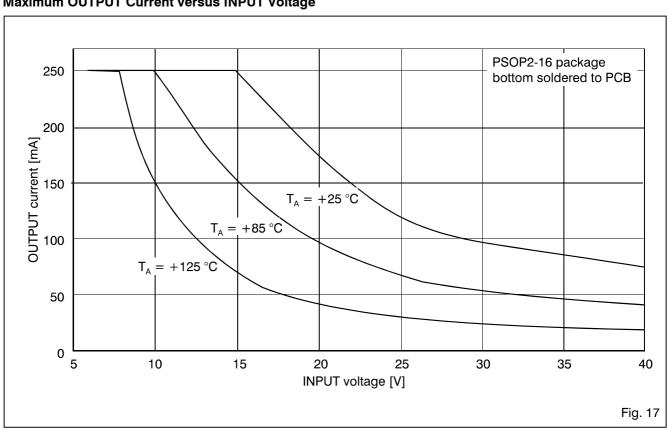
T_{WD} versus Temperature at 5 V



T_{WD} versus R at 5 V



Maximum OUTPUT Current versus INPUT Voltage





Timer Clearing and RES Action

The watchdog circuit monitors the activity of the processor. If the user's software does not send a pulse to the TCL input within the programmed open window timeout period a short watchdog RES pulse is generated which is equal to T_{WD} / 40 = 2.5 ms typically (see Fig. 5). With the open window constraint new security is added to conventional watchdogs by monitoring both software cycle time and execution. Should software clear the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution) it will cause the system to be reset. If software is stuck in a loop which includes the routine to clear the watchdog then a conventional watchdog would not make a system reset even though software is malfunctioning; the A6250 would make a system reset because the watchdog would be cleared too quickly. If no TCL signal is applied before the closed and open windows expire, RES will start to generate square waves of period ($T_{cw} + T_{ow} +$ $\underline{T_{WDR}}$). The watchdog will remain in this state until the next TCL falling edge appears during an open window, or until a fresh power-up sequence. The system enable output, EN, can be used to prevent critical control functions being activated in the event of the system going into this failure mode (see section "Enable - EN Output"). The RES output must be pulled up to V_{OUTPUT} even if the output is not used by the system (see Fig. 8).

Combined Voltage and Timer Action

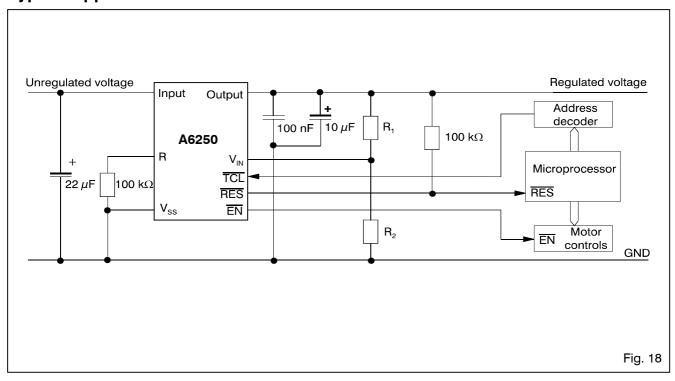
The combination of voltage and timer actions is illustrated by the sequence of events shown in Fig. 6. On power-up, when the voltage at V_{IN} reaches V_{REF} , the power-on-reset, POR, delay is initialized and holds RES active for the time

of the POR delay. A \overline{TCL} pulse will have no effect until this power-on-reset delay is completed. After the POR delay has elapsed, \overline{RES} goes inactive and the watchdog timer starts acting. If no \overline{TCL} pulse occurs, \overline{RES} goes active low for a short time T_{WDR} after each closed and open window period. A \overline{TCL} pulse coming during the open window clears the watchdog timer. When the \overline{TCL} pulse occurs too early (during the closed window), \overline{RES} goes active and a new timeout sequence starts. A voltage drop below the V_{REF} level for longer than typically 5 μ s overrides the timer and immediately forces \overline{RES} active and \overline{EN} inactive. Any further \overline{TCL} pulse has no effect until the next power-up sequence has completed.

Enable - EN Output

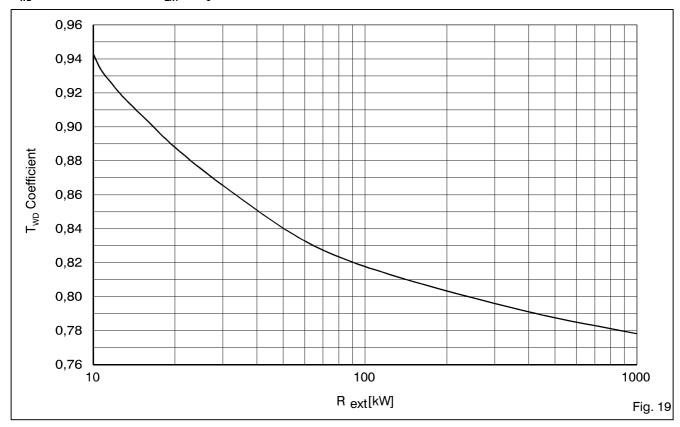
The system enable output, \overline{EN} , is inactive always when RES is active and remains inactive after a RES pulse until the watchdog is serviced correctly 3 consecutive times (ie. the TCL pulse must come in the open window). After three consecutive services of the watchdog with TCL during the open window, the EN goes active low. A malfunctioning system would be repeatedly reset by the watchdog. In a conventional system critical motor controls could be energized each time reset goes inactive (time allowed for the system to restart) and in this way the electrical motors driven by the system could function out of control. The A6250 prevents the above failure mode by using the EN output to disable the motor controls until software has successfully cleared the watchdog three times (ie. the system has correctly restarted after a reset condition).

Typical Application

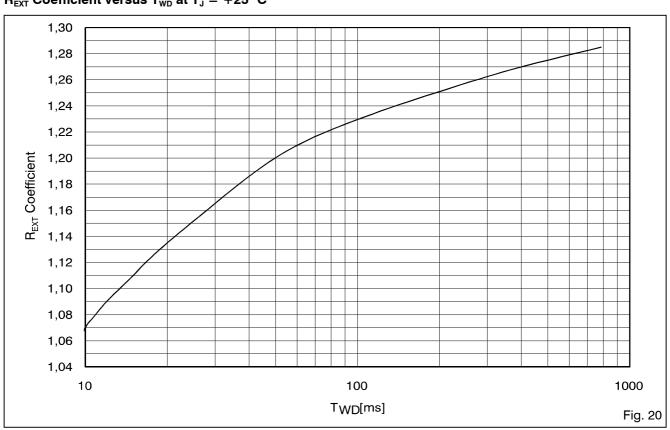




T_{WD} Coefficient versus R_{EXT} at $T_J = \, +25\,\,^{\circ}C$



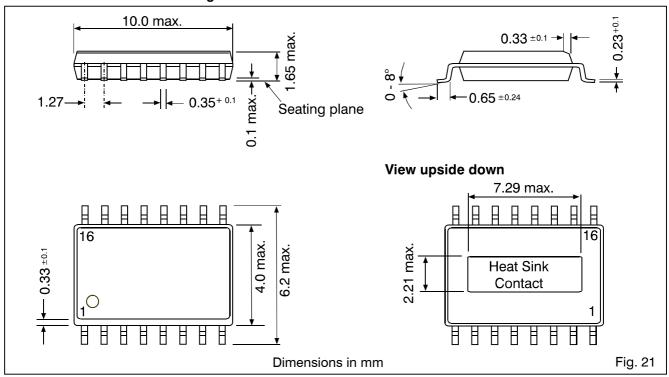
R_{EXT} Coefficient versus T_{WD} at $T_{\text{J}} = \, +25 \,\, ^{\circ}\text{C}$



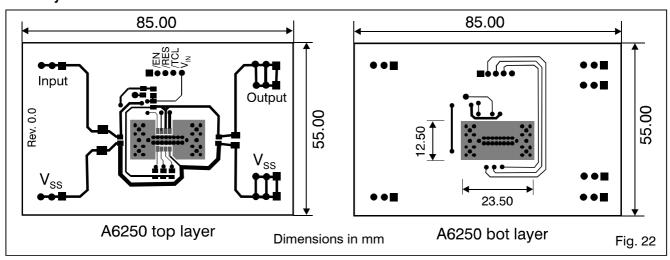


Package and Ordering Information

Dimensions of PSOP2-16 Package



Dual Layer PCB



Ordering Information

The A6250 is available in the following package:

Type Package A6250 X 16W PSOP2-16

When ordering please specify complete part number.

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